

WAFERS DIVISION

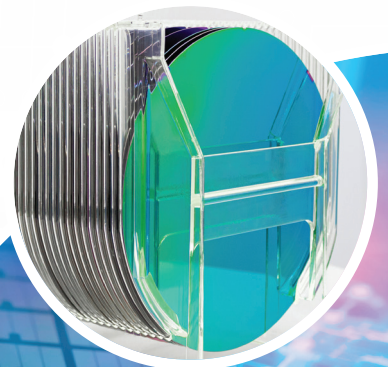
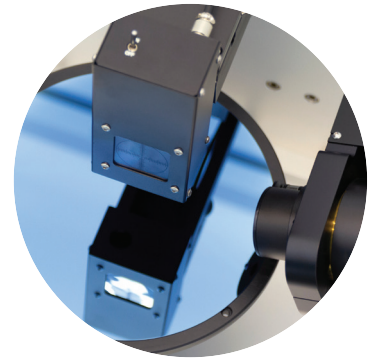
Inseto supplies a wide range of wafers and substrates worldwide, including silicon, compound semiconductor and glass materials.

High-quality semiconductor wafers and substrates for the University, Research and Industrial sectors used in micro- & nano-technology applications, plus those requiring a very flat and exceptionally smooth hydrophobic surface.

With specialist technical advice to help users identify the perfect wafer type for their application, we provide rapid delivery from our large inventory, in addition to on-line purchase options via our wafer store.

Supplying semiconductor wafers and substrates worldwide, Inseto aims to exceed customer expectations and is committed to a policy of continuous improvement throughout the company.

Inseto's other product divisions comprise Equipment and Materials for semiconductor device fabrication, assembly and test, plus Adhesives for electronic, automotive and industrial applications.



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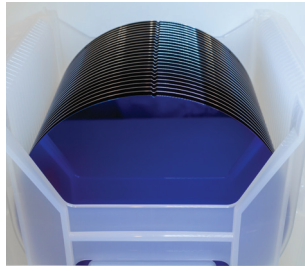


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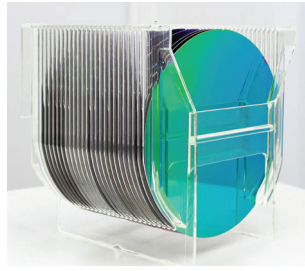
SILICON



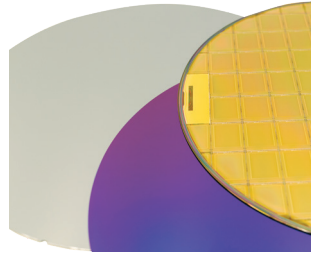
SILICON OXIDE



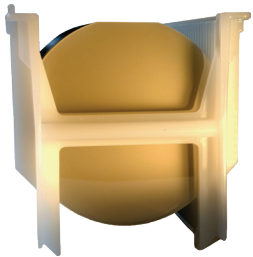
SILICON NITRIDE



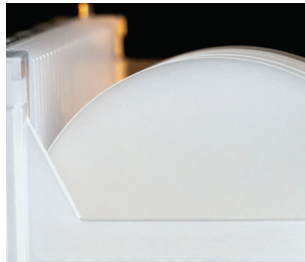
SILICON ON INSULATOR



SILICON ON SAPPHIRE



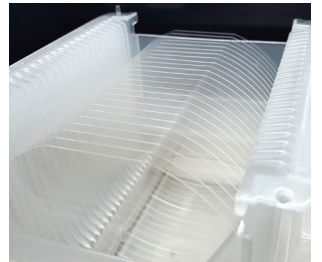
SAPPHIRE



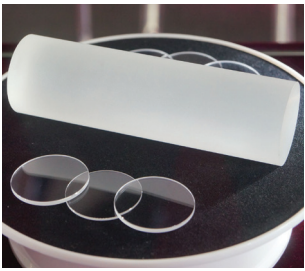
BOROSILICATE GLASS



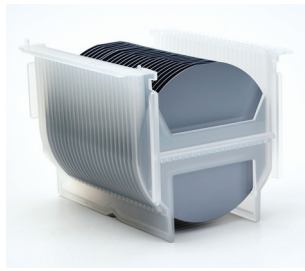
SILICATE GLASS



LITHIUM NIOBATE



GALLIUM NITRIDE



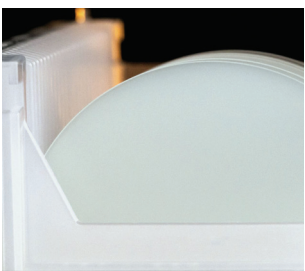
GERMANIUM



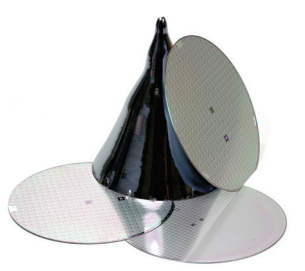
INDIUM PHOSPHIDE



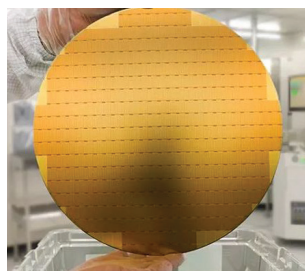
SILICON CARBIDE WAFERS



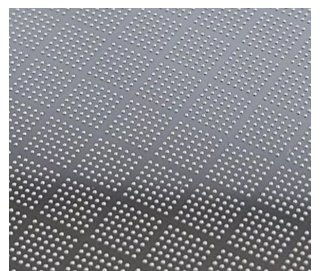
GALLIUM ARSENIDE



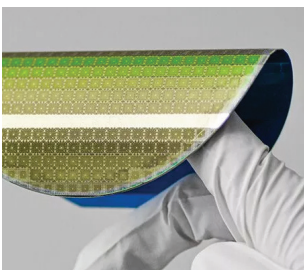
**POLYMER & METAL
WAFER COATINGS**



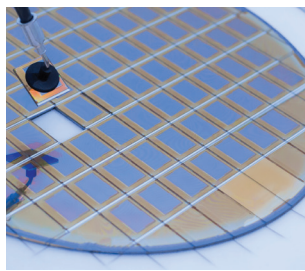
WAFER BUMPING



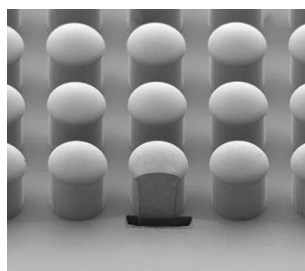
WAFER GRINDING



WAFER DICING



**ADDITION OF ALIGNMENT
GRIDS, RDL & CU PILLARS**



**BUY WAFERS ONLINE VIA
OUR WEB STORE**

